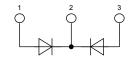


# HiPerFRED<sup>2</sup>

High Performance Fast Recovery Diode Low Loss and Soft Recovery Common Cathode

Part number

**DPG 60 C 300 HB** 



# $V_{RRM} = 300 V$ $I_{FAV} = 2x 30 A$ $t_{rr} = 35 ns$



Backside: cathode

## Features / Advantages:

- Planar passivated chips
- Very low leakage current
- Very short recovery time
- Improved thermal behaviour
- Very low Irm-values
- Very soft recovery behaviour
- Avalanche voltage rated for reliable operation
- Soft reverse recovery for low EMI/RFI
- Low Irm reduces:
- Power dissipation within the diode
- Turn-on loss in the commutating switch

# Applications:

- Antiparallel diode for high frequency switching devices
- Antisaturation diode
- Snubber diode
- Free wheeling diode
- Rectifiers in switch mode power supplies (SMPS)
- Uninterruptible power supplies (UPS)

# Package:

- Housing: TO-247
- Industry standard outline
- Epoxy meets UL 94V-0
- RoHS compliant

### Ratings

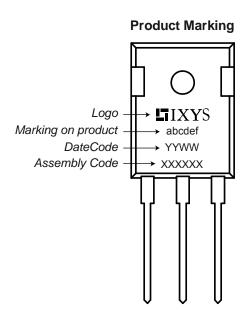
Symbol	Definition	Conditions		min.	typ.	max.	Unit
$V_{RRM}$	max. repetitive reverse voltage		$T_{VJ} = 25^{\circ}C$			300	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 300 V	$T_{VJ} = 25^{\circ}C$			1	μΑ
		$V_R = 300 V$	$T_{VJ} = 150$ °C			0.1	mA
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 30 A	$T_{VJ} = 25^{\circ}C$			1.34	V
		$I_F = 60 A$				1.63	V
		I <sub>F</sub> = 30 A	T <sub>VJ</sub> = 150°C			1.06	V
		$I_F = 60 A$				1.39	V
I <sub>FAV</sub>	average forward current	rectangular d = 0.5	$T_{\rm C}$ = 135°C			30	Α
V <sub>F0</sub>	threshold voltage	and a violation and v	T <sub>vJ</sub> = 175°C			0.70	V
r <sub>F</sub>	slope resistance	calculation only				10.5	mΩ
R <sub>thJC</sub>	thermal resistance junction to case					0.95	K/W
T <sub>VJ</sub>	virtual junction temperature			-55		175	°C
P <sub>tot</sub>	total power dissipation		$T_C = 25^{\circ}C$			160	W
I <sub>FSM</sub>	max. forward surge current	t = 10 ms (50 Hz), sine	T <sub>VJ</sub> = 45°C			360	Α
I <sub>RM</sub>	max. reverse recovery current		$T_{VJ} = 25^{\circ}C$		3		Α
		$I_F = 30 A; V_R = 200 V$	$T_{VJ} = 125$ °C		7		Α
t <sub>rr</sub>	reverse recovery time	$-di_F/dt = 200 A/\mu s$	$T_{VJ} = 25^{\circ}C$		35		ns
			$T_{VJ} = 125$ °C		55		ns
C <sub>J</sub>	junction capacitance	V <sub>R</sub> = 150 V; f = 1 MHz	T <sub>VJ</sub> = 25°C		50		pF



Ratings
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Symbol	Definition	Conditions	min	typ.	max.	Unit
I <sub>RMS</sub>	RMS current	per pin <sup>1)</sup>			50	Α
R <sub>thCH</sub>	thermal resistance case to heatsink			0.25		K/W
T <sub>stg</sub>	storage temperature		-5	5	150	°C
Weight				6		g
M <sub>D</sub>	mounting torque		0.	3	1.2	Nm
F <sub>c</sub>	mounting force with clip		2	ס	120	Ν

<sup>1)</sup> I<sub>RMS</sub> is typically limited by: 1. pin-to-chip resistance; or by 2. current capability of the chip. In case of 1, a common cathode/anode configuration and a non-isolated backside, the whole current capability can be used by connecting the backside.



## Part number

D = Diode

P = HiPerFRED

G = extreme fast

60 = Current Rating [A]

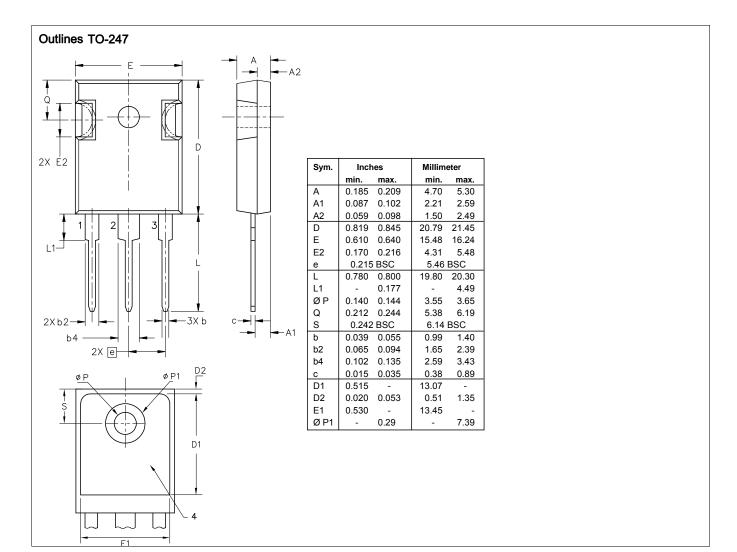
C = Common Cathode

300 = Reverse Voltage [V] HB = TO-247AD (3)

Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Code Key
Standard	DPG 60 C 300 HB	DPG60C300HB	Tube	30	502163

Similar Part	Package	Voltage Class
DPG60C300QB	TO-3P (3)	300
DPG60C300HJ	ISOPLUS247 (3)	300
DPG60C300PC	TO-263AB (D2Pak)	300
DPF60C300HB	TO-247AD (3)	300
DPG80C300HB	TO-247AD (3)	300







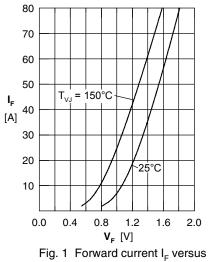


Fig. 1 Forward current I<sub>F</sub> versus forward voltage V<sub>F</sub>

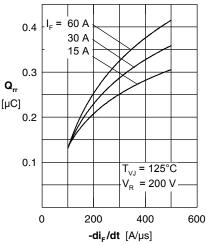


Fig. 2 Typ. reverse recovery charge  $Q_{rr}$  versus  $-di_F/dt$ 

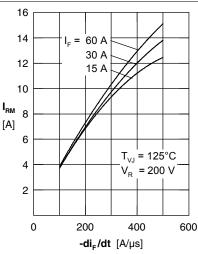


Fig. 3 Typ. reverse recovery current  $I_{RM}$  versus  $-di_{F}/dt$ 

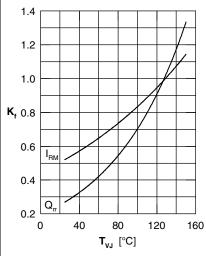


Fig. 4 Dynamic parameters  $Q_{rr}$ ,  $I_{RM}$  versus  $T_{VJ}$ 

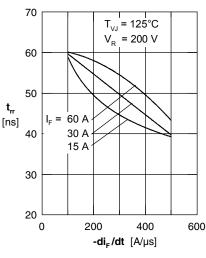


Fig. 5 Typ. reverse recovery time  $t_{rr}$  versus  $-di_{F}/dt$ 

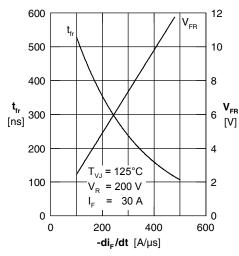


Fig. 6 Typ. forward recovery voltage  $V_{FR}$ & forward recovery time  $t_{fr}$  vs.  $di_{F}/dt$ 

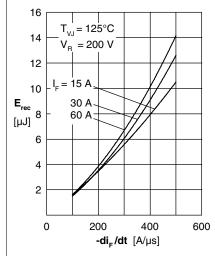


Fig. 7 Typ. recovery energy  $E_{rec}$  versus  $-di_F/dt$ 

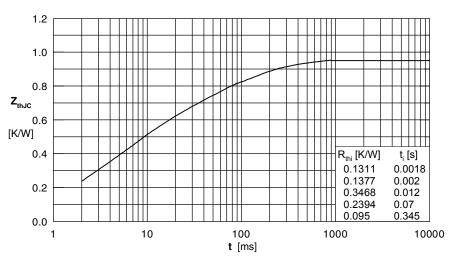


Fig. 8 Transient thermal impedance junction to case